Bill of Materials

TI DESIGNS TIDA-00208 Single-Ended Signal Conditioning Circuit for Current and Voltage Measurement Using F

Qty	Reference	Part Description	Manufacturer	Manufacturer	PCB Footprint	Note
-				Part Number	•	
1	!PCB	Printed Circuit Board	Any Taivo Yudon	TIDA-00208 EMK107BBJ106MA-T	0603	Fitted
1	C4	CAP, CERM, 10uF, 16V, +/-20%, X5R, 0603	Taiyo Yuden			Fitted
1	D1	Diode, Schottky, 60V, 1A, SMA	ON Semiconductor	MBRA160T3G	SMA	Fitted
1	J10	Receptacle, 100mil, 3x1, TH	TE Connectivity	534237-1	Recptacle, 100mil, 3x1	Fitted
1	J13	Connector, DC Jack 2.1X5.5 mm, TH	CUI Inc.	PJ-102A	POWER JACK, 14.4x11x9mm	Fitted
1	J15	Header, Male 8-pin, 100mil spacing,	Sullins	PEC08SAAN	0.100 inch x 8	Fitted
1	19	Terminal Block, 2x1, 2.54mm, TH	TE Connectivity	282834-2	Terminal Block, 2x1, 2.54mm, TH	Fitted
		Thermal Transfer Printable Labels, 0.650" W x 0.200" H				
1	LBL1	- 10,000 per roll	Brady	THT-14-423-10	PCB Label 0.650"H x 0.200"W	Fitted
1	R13	RES, 1.00k ohm, 1%, 0.1W, 0603	Yageo America	RC0603FR-071KL	0603	Fitted
		Low-Noise, Very Low Drift, Precision VOLTAGE				
1	U11	REFERENCE, 2.5V, D008A	Texas Instruments	REF5025AID	D0008A	Fitted
1	U12	DUAL OUTPUT VOLTAGE REFERENCE 3.3V, DBV0005A	Texas Instruments	REF2033DBV	DBV0005A	Fitted
		20 MHz, Low Noise, RRIO, CMOS Operational Amplifier,				
		1.8 to 5.5 V, -40 to 125 degC, 14-pin SOP (PW0014A),				
1	U13	Green (RoHS & no Sb/Br)	Texas Instruments	OPA4322AIPW	PW0014A	Fitted
-		Single Output LDO, 200 mA, Fixed 3.3 V Output, 2 to				
		5.5 V Input, with Low IQ, 5-pin SC70 (DCK), -40 to 125				
1	U14	degC, Green (RoHS & no Sb/Br)	Texas Instruments	TLV70033DCKR	DCK0005A	Fitted
1	014		Texas instruments	TEV/0033DCKR	DCK0003A	Filleu
4	1145	36-V, 1-A, 4.17-μVRMS, RF LDO Voltage Regulator,	-		D.C.W/00204	5 ¹ 111111
1	U15	RGW0020A	Texas Instruments	TPS7A4700RGW	RGW0020A	Fitted
		20 MHz, Low Noise, RRIO, CMOS Operational Amplifier				
		with Shutdown, 1.8 to 5.5 V, -40 to 125 degC, 5-pin				
1	U5	SOT23 (DBV0005A), Green (RoHS & no Sb/Br)	Texas Instruments	OPA322AIDBVR	DBV0005A	Fitted
	R1, R3, R4, R6, R7, R9, R10, R12,					
10	R22, R24	RES, 3.30k ohm, 1%, 0.1W, 0603	Yageo America	RC0603FR-073K3L	0603	Fitted
	C1, C2, C6, C7, C8, C9, C15, C36,					
11	C37, C38, C42	CAP, CERM, 0.1uF, 16V, +/-5%, X7R, 0603	Kemet	C0603C104J4RACTU	0603	Fitted
2	J11, J14	CONN RCPT 20POS .100 DL STR SMD	FCI	89898-310ALF		Fitted
2	U16, U17	IC ADC 12BIT 1MSPS DUAL 16TSSOP	Texas Instruments	ADS7853	16TSSOP	Fitted
3	C3, C44, C51	CAP, CERM, 0.1uF, 10V, +/-10%, X7R, 0603	Kemet	C0603C104K8RACTU	0603	Fitted
3	LD1, LD2, LD3	LED SmartLED Green 570NM	OSRAM	LG L29K-G2J1-24-Z	0603	Fitted
_						
3	R15, R18, R19	RES, 1.0k ohm, 5%, 0.1W, 0603	Vishay-Dale	CRCW06031K00JNEA	0603	Fitted
3	R16, R21, R34	RES, 10k ohm, 5%, 0.1W, 0603	Vishay-Dale	CRCW060310K0JNEA	0603	Fitted
4	C40, C41, C47, C48	CAP, CERM, 1000pF, 25V, +/-5%, C0G/NP0, 0603	MuRata	GRM1885C1E102JA01D	0603	Fitted
4	J5, J6, J7, J8	Connector, TH, SMA	Emerson Network Power	142-0701-201	SMA	Fitted
4	R41, R94, R96, R97	RES, 10.0 ohm, 0.1%, 0.1W, 0603	Yageo America	RT0603BRD0710RL	0603	Fitted
4	R48, R49, R50, R51	RES, 0.1 ohm, 1%, 0.1W, 0603	Panasonic	ERJ-3RSFR10V	0603	Fitted
4	U1, U2, U3, U4	SENSOR CURRENT 50A 5V MOD	LEM USA Inc	CKSR X-NP	Module	Fitted
5	C16, C20, C23, C24, C25	CAP, CERM, 10uF, 16V, +/-10%, X5R, 0805	MuRata	GRM21BR61C106KE15L	0805	Fitted
5	C34, C52, C53, C54, C55	CAP, CERM, 1uF, 25V, +/-10%, X7R, 0603	MuRata	GRM188R71E105KA12D	0603	Fitted
		Machine Screw, Round, #4-40 x 1/4, Nylon, Philips				
5	H1, H2, H3, H5, H6	panhead	B&F Fastener Supply	NY PMS 440 0025 PH	Screw	Fitted
5	H4, H7, H8, H9, H10	Standoff, Hex, 0.5"L #4-40 Nylon	Keystone	1902C	Standoff	Fitted
5	J1, J2, J3, J4, J12	Conn Term Block, 2POS, 3.5mm, TH	Phoenix Contact	1751248	11x8.5x7.3mm	Fitted
5	R2, R5, R8, R11, R23	RES, 20.0k ohm, 1%, 0.1W, 0603	Vishay-Dale	CRCW060320K0FKEA	0603	Fitted
5	U6, U7, U8, U9, U10	IC, Dual Differential Comparators, 2-36 Vin	TI	TLC372	SO-8	Fitted
5				120372	50 0	Thee
	R14, R20, R27, R43, R44, R45,					
	R46, R53, R55, R57, R58, R59,					
	R62, R63, R68, R70, R72, R73,					
	R75, R76, R77, R78, R79, R80,					
	R81, R82, R83, R84, R85, R86,					
	R87, R88, R89, R90, R91, R92,					
	R93, R103, R104, R105, R106,					
	R107, R108, R109, R110, R111,					
	R112, R113, R114, R115, R116,					
54	R117, R118, R119	RES, 0 ohm, 5%, 0.1W, 0603	Vishay-Dale	CRCW06030000Z0EA	0603	Fitted
6	C5, C10, C12, C14, C21, C35	CAP, CERM, 1uF, 10V, +/-10%, X7R, 0805	Kemet	C0805C105K8RACTU	0805	Fitted
	FID1, FID2, FID3, FID4, FID5,					
6	FID6	Fiducial mark. There is nothing to buy or mount.	N/A	N/A	Fiducial	Fitted
7	D2, D3, D4, D5, D6, D7, D8	Diode, Zener, 3.6V, 500mW, SOD-123	Diodes Inc.	MMSZ5227B-7-F	SOD-123	Fitted
-	R52, R54, R60, R61, R64, R65,					
7	R66	RES, 47 ohm, 5%, 0.1W, 0603	Vishay-Dale	CRCW060347R0JNEA	0603	Fitted
/	C19, C22, C39, C43, C45, C46,	ALS, 47 OHH, 570, 0.1W, 0005	visitay-Dale		0005	i itteu
0				C1609C0C4FFC21	0000	F : 4 + ¹
8	C49, C50	CAP, CERM, 5600pF, 25V, +/-5%, C0G/NP0, 0603	TDK	C1608C0G1E562J	0603	Fitted
-	C26, C27, C28, C29, C30, C31,					
8	C32, C33	CAP, CERM, 10uF, 25V, +/-20%, X5R, 0603	TDK	C1608X5R1E106M080AC	0603	Fitted
	R25, R26, R30, R31, R37, R40,					
8	R95, R98	RES, 1.50 k, 1%, 0.1 W, 0603	Vishay-Dale	CRCW06031K50FKEA	0603	Fitted
	R28, R29, R32, R33, R35, R36,					
		RES, 2.00 k, 1%, 0.1 W, 0603	Vishay-Dale	CRCW06032K00FKEA	0603	Fitted
8	R38. R39		,			Not Fitted
8	R38, R39 C11, C13, C17, C18		Kemet	C0603H103I3GACTU	0603	NULENIEU
8 0	C11, C13, C17, C18	CAP, CERM, 0.01uF, 25V, +/-5%, COG/NP0, 0603	Kemet	C0603H103J3GACTU	0603	NOLFILLEU
0	C11, C13, C17, C18 R17, R42, R47, R67, R69, R71,	CAP, CERM, 0.01uF, 25V, +/-5%, COG/NP0, 0603				
0	C11, C13, C17, C18 R17, R42, R47, R67, R69, R71, R74, R120, R121, R123, R124	CAP, CERM, 0.01uF, 25V, +/-5%, COG/NPO, 0603 RES, 0 ohm, 5%, 0.1W, 0603	Vishay-Dale	CRCW06030000Z0EA	0603	Not Fitted
0	C11, C13, C17, C18 R17, R42, R47, R67, R69, R71,	CAP, CERM, 0.01uF, 25V, +/-5%, COG/NP0, 0603				

IMPORTANT NOTICE FOR TI REFERENCE DESIGNS

Texas Instruments Incorporated ("TI") reference designs are solely intended to assist designers ("Buyers") who are developing systems that incorporate TI semiconductor products (also referred to herein as "components"). Buyer understands and agrees that Buyer remains responsible for using its independent analysis, evaluation and judgment in designing Buyer's systems and products.

TI reference designs have been created using standard laboratory conditions and engineering practices. **TI has not conducted any testing other than that specifically described in the published documentation for a particular reference design.** TI may make corrections, enhancements, improvements and other changes to its reference designs.

Buyers are authorized to use TI reference designs with the TI component(s) identified in each particular reference design and to modify the reference design in the development of their end products. HOWEVER, NO OTHER LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE TO ANY OTHER TI INTELLECTUAL PROPERTY RIGHT, AND NO LICENSE TO ANY THIRD PARTY TECHNOLOGY OR INTELLECTUAL PROPERTY RIGHT, IS GRANTED HEREIN, including but not limited to any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services, or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

TI REFERENCE DESIGNS ARE PROVIDED "AS IS". TI MAKES NO WARRANTIES OR REPRESENTATIONS WITH REGARD TO THE REFERENCE DESIGNS OR USE OF THE REFERENCE DESIGNS, EXPRESS, IMPLIED OR STATUTORY, INCLUDING ACCURACY OR COMPLETENESS. TI DISCLAIMS ANY WARRANTY OF TITLE AND ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, QUIET ENJOYMENT, QUIET POSSESSION, AND NON-INFRINGEMENT OF ANY THIRD PARTY INTELLECTUAL PROPERTY RIGHTS WITH REGARD TO TI REFERENCE DESIGNS OR USE THEREOF. TI SHALL NOT BE LIABLE FOR AND SHALL NOT DEFEND OR INDEMNIFY BUYERS AGAINST ANY THIRD PARTY INFRINGEMENT CLAIM THAT RELATES TO OR IS BASED ON A COMBINATION OF COMPONENTS PROVIDED IN A TI REFERENCE DESIGN. IN NO EVENT SHALL TI BE LIABLE FOR ANY ACTUAL, SPECIAL, INCIDENTAL, CONSEQUENTIAL OR INDIRECT DAMAGES, HOWEVER CAUSED, ON ANY THEORY OF LIABILITY AND WHETHER OR NOT TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES, ARISING IN ANY WAY OUT OF TI REFERENCE DESIGNS OR BUYER'S USE OF TI REFERENCE DESIGNS.

TI reserves the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques for TI components are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

Reproduction of significant portions of TI information in TI data books, data sheets or reference designs is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards that anticipate dangerous failures, monitor failures and their consequences, lessen the likelihood of dangerous failures and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in Buyer's safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed an agreement specifically governing such use.

Only those TI components that TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components that have **not** been so designated is solely at Buyer's risk, and Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2014, Texas Instruments Incorporated